



Features

- RoHS compliant*
- Protects 1 or 2 lines
- Unidirectional & bidirectional configurations
- ESD protection 30 kV max.

Applications

- RS-232, RS-422 & RS-423 data lines
- Portable electronics
- Wireless bus protection
- Control & monitoring systems

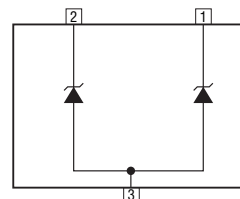
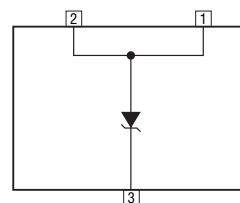
CDSOT23-T03~T36C — TVS Diode Array Series

General Information

The markets of portable communications, computing and video equipment are challenging the semiconductor industry to develop increasingly smaller electronic components.

Bourns offers Transient Voltage Suppressor Array diodes for surge and ESD protection applications, in compact chip package SOT23 size format. The Transient Voltage Suppressor Array series offers a choice of voltage types ranging from 3 V to 36 V. Bourns® Chip Diodes conform to JEDEC standards, are easy to handle on standard pick and place equipment and their flat configuration minimizes roll away.

The Bourns device will meet IEC 61000-4-2 (ESD), IEC 61000-4-4 (EFT) and IEC 61000-4-5 (Surge) requirements.



Thermal Characteristics (@ $T_A = 25^\circ\text{C}$ Unless Otherwise Noted)

Parameter	Symbol	Value	Unit
Operating Temperature	T_J	-55 to +150	$^\circ\text{C}$
Storage Temperature	T_{STG}	-55 to +150	$^\circ\text{C}$

Electrical Characteristics (@ $T_A = 25^\circ\text{C}$ Unless Otherwise Noted)

Parameter	Symbol	CDSOT23-														Unit
		Uni-	Bi-	Uni-	Bi-	Uni-	Bi-	Uni-	Bi-	Uni-	Bi-	Uni-	Bi-	Uni-	Bi-	
		T03	T03C	T05	T05C	T08	T08C	T12	T12C	T15	T15C	T24	T24C	T36	T36C	
Breakdown Voltage @ 1 mA	V_{BR}	4.0		6.0		8.5		13.3		16.7		26.7		40.0		V
Working Peak Voltage	V_{WM}	3.3		5.0		8.0		12.0		15.0		24.0		36.0		V
Maximum Clamping Voltage V_C @ $I_P = 1\text{ A}^1$	V_F	7.0		9.8		13.4		19.0		24.0		43.0		51.0		V
Maximum Clamping Voltage @ 8/20 μs V_C @ I_{PP}^1	V_F	10.9 V @ 43 A		13.5 V @ 42 A		16.9 V @ 34 A		25.9 V @ 21 A		30.0 V @ 17 A		49.0 V @ 12 A		76.8 V @ 9 A		V
Maximum Leakage Current @ V_{WM}	I_D	125		20		10		2		1		1		1		μA
Typical Cap Unidirectional @ 0 V, 1 MHz	$C_{j(SD)}$	500		350		250		150		100		88		80		pF
Typical Cap Bidirectional @ 0 V, 1 MHz	$C_{j(SD)}$	300		210		150		90		60		63		60		pF
ESD Protection: IEC 61000-4-2 Contact - Min. Contact - Max. Air - Min. Air - Max.	ESD	± 8 ± 30 ± 15 ± 30														kV
Peak Pulse Power ($t_p = 8/20\ \mu\text{s}$) ²	P_{PP}	500														W
Forward Voltage @ 100 mA, 300 μs – Square Wave ³	V_F	1.5														V

Notes:

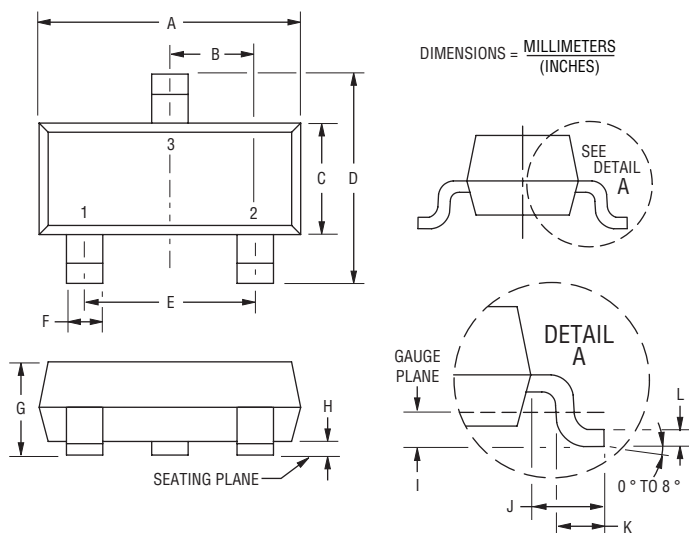
1. See Pulse Wave Form.
2. See Peak Pulse Power vs. Pulse Time.
3. Only applies to unidirectional devices.
4. Part numbers with a "C" suffix are bidirectional devices, i.e., CDSOT23-T03C.

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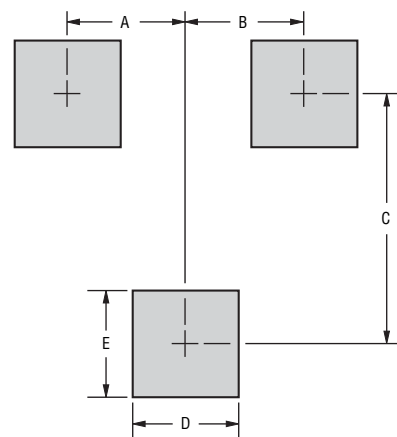
Product Dimensions

This is a molded JEDEC SOT-23 package with lead free 100 % Sn plating on the lead frame. It weighs approximately 0.6 g and has a flammability rating of UL 94V-0.



Dimensions	
A	$\frac{2.80 - 3.00}{(0.110 - 0.118)}$
B	$\frac{0.95}{(0.037)}$ BSC
C	$\frac{1.20 - 1.40}{(0.047 - 0.055)}$
D	$\frac{2.10 - 2.49}{(0.083 - 0.098)}$
E	$\frac{1.90}{(0.075)}$ BSC
F	$\frac{0.30 - 0.50}{(0.012 - 0.019)}$
G	$\frac{0.89 - 1.17}{(0.035 - 0.046)}$
H	$\frac{0.05 - 0.015}{(0.002 - 0.006)}$
I	$\frac{0.25}{(0.010)}$ BSC
J	$\frac{0.46 - 0.64}{(0.018 - 0.025)}$
K	$\frac{0.40 - 0.58}{(0.016 - 0.023)}$
L	$\frac{0.08 - 0.20}{(0.003 - 0.008)}$

Recommended Footprint



DIMENSIONS = $\frac{\text{MILLIMETERS}}{(\text{INCHES})}$

Dimensions	
A	$\frac{0.95}{(0.037)}$
B	$\frac{0.95}{(0.037)}$
C	$\frac{2.00}{(0.079)}$
D	$\frac{0.85}{(0.033)}$
E	$\frac{0.85}{(0.033)}$

How To Order

Common Code _____
 Chip Diode
 Package _____
 • SOT23 = SOT23 Package
 Model _____
 T = Transient Voltage Suppressor
 Working Peak Voltage _____
 3 = 3 V_{RWM} (Volts)
 Suffix _____
 C = Bidirectional Diode

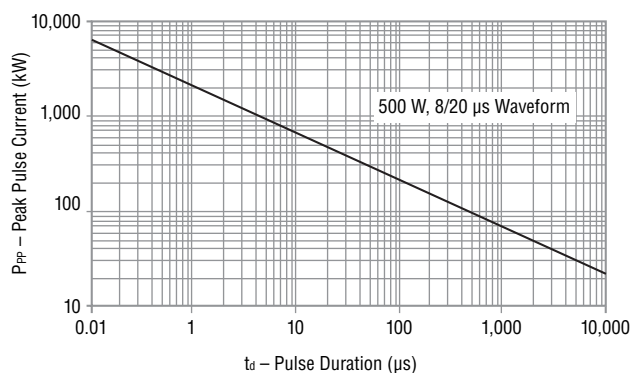
CD SOT23 - T 03 C

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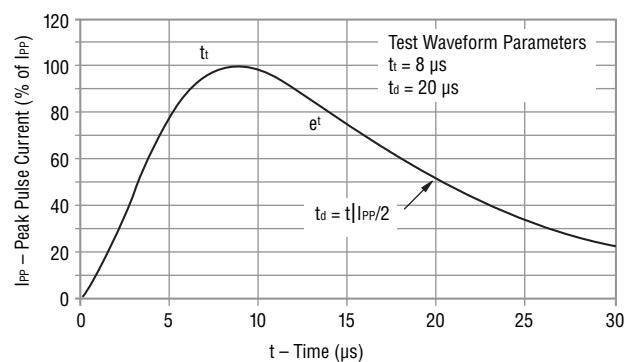
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Performance Graphs

Peak Pulse Power vs Pulse Time



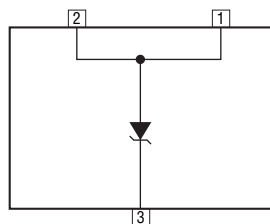
Pulse Wave Form



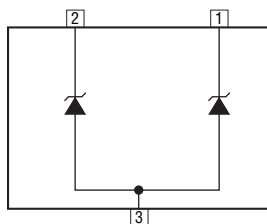
Block Diagram

The device block diagrams below include the pin names and basic electrical connections associated with each channel.

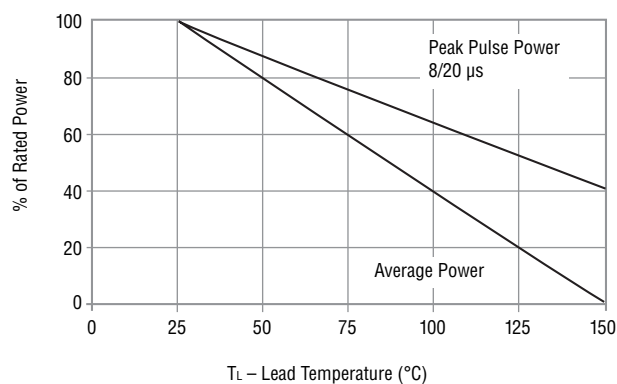
Unidirectional



Bidirectional



Power Derating Curve



Typical Part Marking

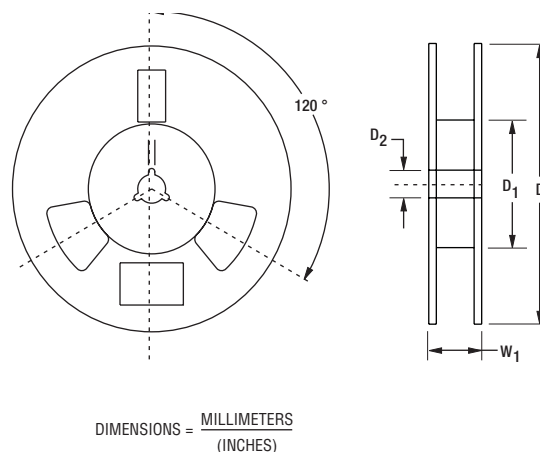
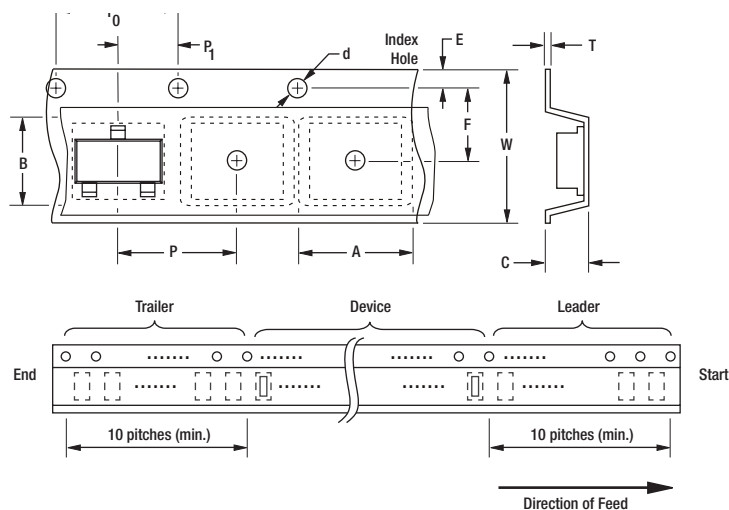
Part Number	Top Side Mark
CDSOT23-T03	03
CDSOT23-T03C	03C
CDSOT23-T05	05
CDSOT23-T05C	05C
CDSOT23-T08	08
CDSOT23-T08C	08C
CDSOT23-T12	12
CDSOT23-T12C	12C
CDSOT23-T15	15
CDSOT23-T15C	15C
CDSOT23-T24	24
CDSOT23-T24C	24C
CDSOT23-T36	36
CDSOT23-T36C	36C

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Packaging

The surface mount product is packaged in a 12 mm x 8 mm Tape and Reel format per EIA-481 standard.



Item	Symbol	SOT23
Carrier Width	A	$\frac{2.25 \pm 0.10}{(0.088 \pm 0.004)}$
Carrier Length	B	$\frac{2.34 \pm 0.10}{(0.092 \pm 0.004)}$
Carrier Depth	C	$\frac{1.22 \pm 0.10}{(0.048 \pm 0.004)}$
Sprocket Hole	d	$\frac{1.55 \pm 0.05}{(0.061 \pm 0.002)}$
Reel Outside Diameter	D	$\frac{178}{(7.008)}$
Reel Inner Diameter	D ₁	$\frac{50.0}{(1.969)}$ Min.
Feed Hole Diameter	D ₂	$\frac{13.0 \pm 0.20}{(0.512 \pm 0.008)}$
Sprocket Hole Position	E	$\frac{1.75 \pm 0.10}{(0.069 \pm 0.004)}$
Punch Hole Position	F	$\frac{3.50 \pm 0.05}{(0.138 \pm 0.002)}$
Punch Hole Pitch	P	$\frac{4.00 \pm 0.10}{(0.157 \pm 0.004)}$
Sprocket Hole Pitch	P ₀	$\frac{4.00 \pm 0.10}{(0.157 \pm 0.004)}$
Embossment Center	P ₁	$\frac{2.00 \pm 0.05}{(0.079 \pm 0.002)}$
Overall Tape Thickness	T	$\frac{0.20 \pm 0.10}{(0.008 \pm 0.004)}$
Tape Width	W	$\frac{8.00 \pm 0.20}{(0.315 \pm 0.008)}$
Reel Width	W ₁	$\frac{14.4}{(0.567)}$ Max.
Quantity per Reel	—	3,000

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REV. 07/12

Specifications are subject to change without notice.
Customers should verify actual device performance in their specific applications.

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В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

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